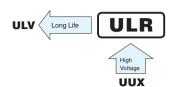


Chip Type, High Voltage.



- Chip Type, high Voltage.
- Applicable to automatic mounting machine using carrier tape.
- Adapted to the RoHS directive (2011/65/EU).

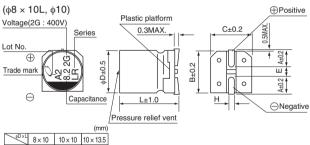




■Specifications

Item	Performance Characteristics							
Category Temperature Range	-40 to +105°C							
Rated Voltage Range	160 to 500V							
Rated Capacitance Range	2.7 to 39μF							
Capacitance Tolerance	±20% at 120Hz, 20°C							
Leakage Current	After 1 minute's application of rated voltage, leakage current is not more than 0.04CV +100(µA).							
Tangent of loss angle (tan δ)	Measurement frequency : 120Hz at 20°C Rated voltage (V) 160 200 250 400 450 500 tan δ (MAX.) 0.20 0.25 0.25 0.30 0.30							
	Measurement frequency: 120Hz							
Stability at Low Temperature	Rated voltage (V) 160 200 250 400 450 500							
otability at Low Tomporatare	Impedance ratio Z-40°C / Z+20°C 6 6 10 15 15							
Endurance	The specifications listed at right shall be met when the capacitors are restored to 20°C after the rated voltage is applied for 3000 hours at 105°C. Capacitance change Within ±20% of the initial capacitance value tan δ 200% or less than the initial specified value Leakage current Less than or equal to the initial specified value							
Shelf Life	After storing the capacitors under no load at 105°C for 1000 hours and then performing voltage treatment based on JIS C 5101-4 clause 4.1 at 20°C, they shall meet the specified values for the endurance characteristics listed above.							
Resistance to soldering heat	The capacitors are kept on a hot plate for 30 seconds, which is maintained at 250°C and then performing voltage treatment based on JIS C 5101-4 clause 4.1 at 20°C, they shall meet the characteristic requirements listed at right when they are removed from the plate. Capacitance change Within $\pm 10\%$ of the initial capacitance value $\tan \delta$ Less than or equal to the initial specified value Leakage current Less than or equal to the initial specified value							
Marking	Black print on the case top.							

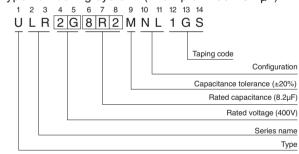
■Chip Type



			(mm)
φD×L	8×10	10×10	10 × 13.5
Α	2.9	3.2	3.2
В	8.3	10.3	10.3
С	8.3	10.3	10.3
E	3.1	4.5	4.5
L	10	10	13.5
Н	0.8 to 1.1	0.8 to 1.1	0.8 to 1.1

Voltage						
V	160	200	250	400	450	500
Code	2C	2D	2E	2G	2W	2H

Type numbering system (Example : $400V 8.2 \mu F$)



Dimensions

	V	16	60	20	00	25	50	40	0	45	50	500	0
Cap.(µF)	Code	2	C	2	D	2	E	20	3	2V	N	2H	1
2.7	2R7						l I					8×10	20
3.9	3R9							!		8×10	25	10×10 ¦	35
4.7	4R7						i	8×10	35	i		i	
5.6	5R6											10 × 13.5	40
6.8	6R8						!	!		10×10	40	!	
8.2	8R2						i	10×10	50	i		i	
10	100					8×10	35			10 × 13.5	45		
12	120			8×10	50		1	10 × 13.5	55			!	
15	150	8×10	50			10×10	50			i		i	
22	220			10×10	65	10 × 13.5	55						
27	270	10 × 10	65				!	!		!		!	
33	330			10 × 13.5	70							Case size	Rated
39	390	10 × 13.5	70									φD×L(mm)	ripple

Rated ripple current (mArms) at 105°C 120Hz

• Frequency coefficient of rated ripple current

	•				JP.0 00.	
Frequency		50 Hz	120 Hz	300 Hz	1 kHz	10 kHz or more
	Coefficient	0.80	1.00	1.25	1.40	1.60

- Taping specifications are given in page 23.
- Recommended land size, soldering by reflow are given in page 18, 19.
- Please refer to page 3 for the minimum order quantity.

CAT.8100E